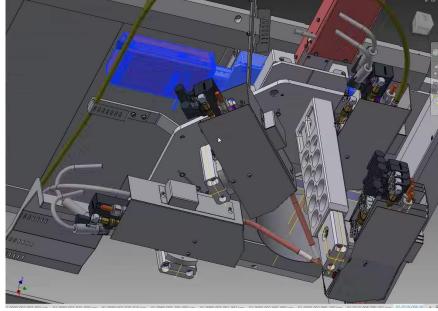


Wire electron beam additive manufacturing (WEBAM)

What can a wire feeder bring to electron beam welding?

- Wire electron beam additive manufacturing
 - Create semifinished products with freedom in geometry, size and material
- Repair
 - Replace lost material
- Compensation for imprecise joint preparations or gaps between components
- Alloying and cladding
 - To improve properties of weld or surface (wear resistance, oxidation resistance, ...)





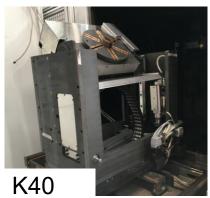
Machines and pro-beam differentiators

Machines with wire feeder available at pro-beam

- 4 machines with wire DED capabilities available
 - PB WEBAM 100: multi-axis machine
 - K40: multi-axis machine
 - K190: tubular machine
 - K6000-1: machine for large and heavy components, internal robot-controlled generator

	PB WEBAM 100	K40	K190	K6000-1
X [mm]	1270 (T)	420 (T)	4900 (T)	11400 (G, WF)
Y [mm]	800 (T) [+ 1100 (G, WF)]	435 (T)	50 (G, WF)	2000 (G, WF)
Z [mm]	1200 (T)	317 (T)	220 (WF)	6000 (G, WF)
Further axes	A (±90), C(∞)	A(+90), C (∞)	A (∞)	A (∞), C (∞)
Beam power [kW]	9	7.5	45	40



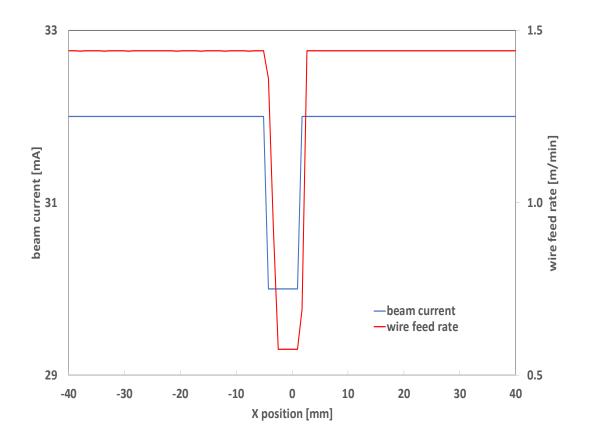


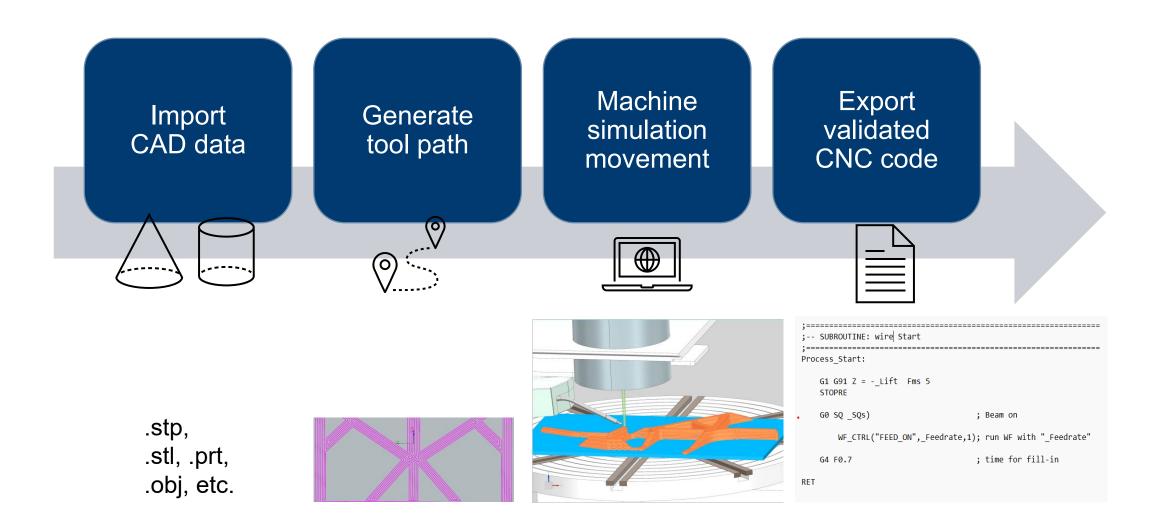




Computerized numerical control

- CNC of all relevant mechanical (including wire feed rate) and electron beam parameters
 - G-code
- Manual changes during development phase also possible
- Example: In-process WEBAM data (beam current, wire feed rate, x position)



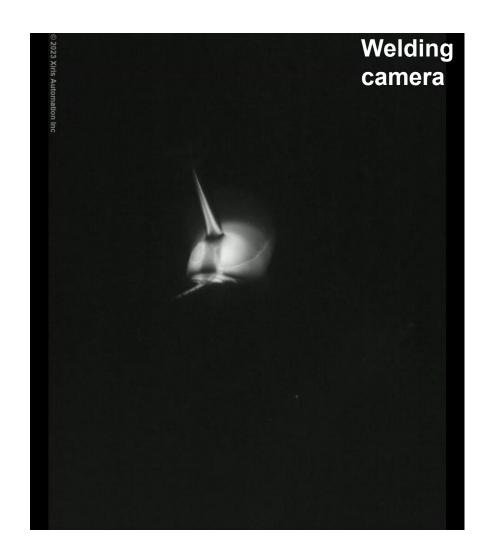


Complex titanium components realized by CAD/CAM



Process-documentation

- Automated data logging of all important process parameters at 10 Hz (up to 60 different parameters)
 - Beam parameters (current, voltage, oscillation, ...)
 - Mechanical parameters (X, Y, Z, rotation angle, ...)
 - Feed rate
 - Temperature
 - Wire parameters (wire feed rate, 2n wire feed rate to document slip, ...)
 - Vacuum



Key process parameters

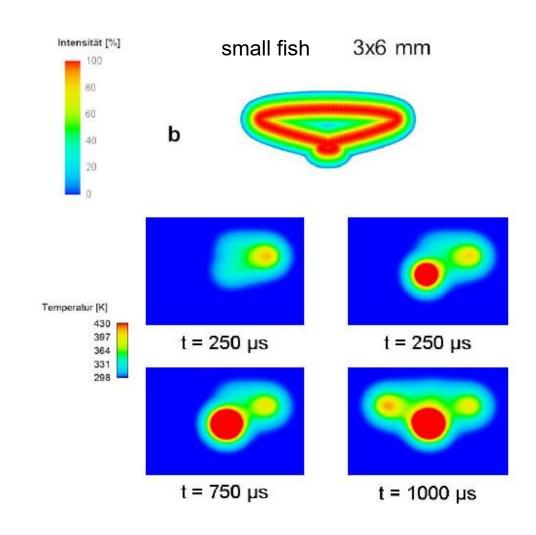
pro beam

Similar to most DED technologies:

 Feed rate, wire feed rate, layer height, power (voltage, beam current)

Unique for WEBAM:

- Energy density distribution by beam oscillation
 - Oscillation freely programmable (for example, the wire area can be considered)
 - Size (x, y) and frequency can be programmed
 - Separation in two energy density distributions for wire and melt bead area can be programmed
 - Beam current for these areas can be changed separately over the layers
- · Focus position can be controlled



Free control of energy density distribution

pro beam

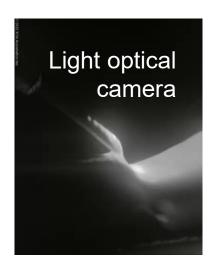
Size and shape of oscillation determines wall width

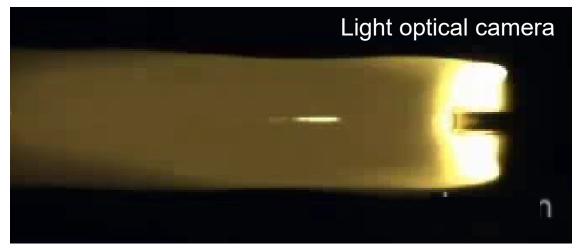
- Depending on oscillation different wall widths possible
- One wire diameter (1.2 mm) can result in single track wall widths between 5 mm and 15 mm



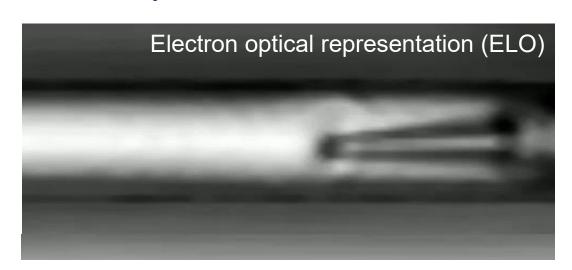
Visual systems

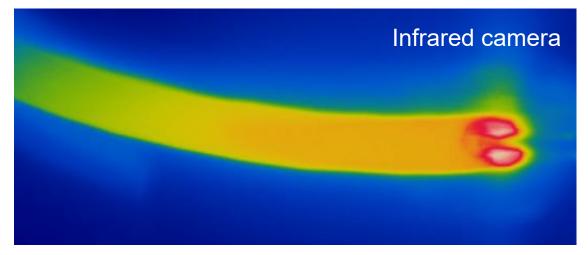
- In-situ process monitoring for parameter development
- Documentation of the melt bead



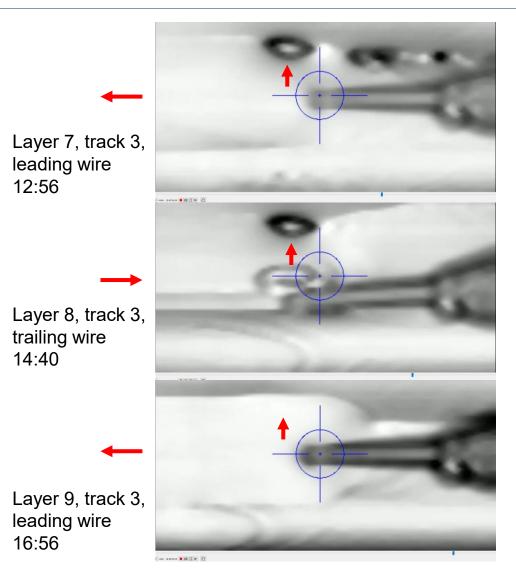


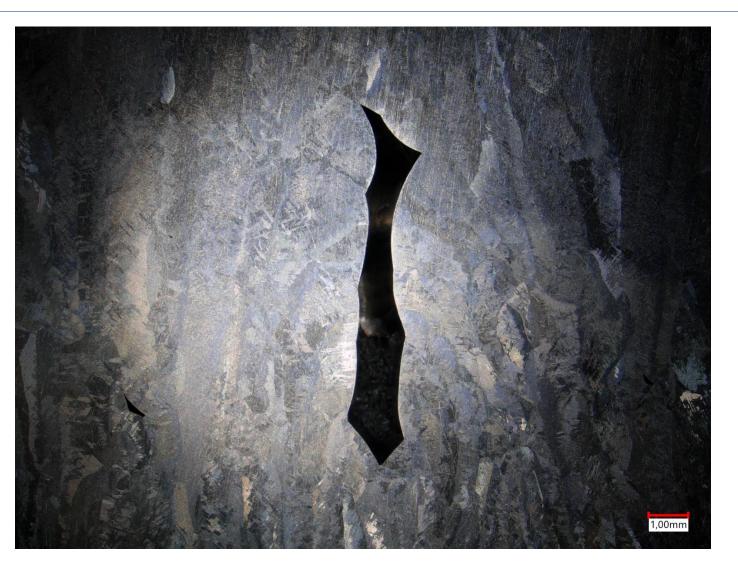
Thermocouples





In process ELO defect detection



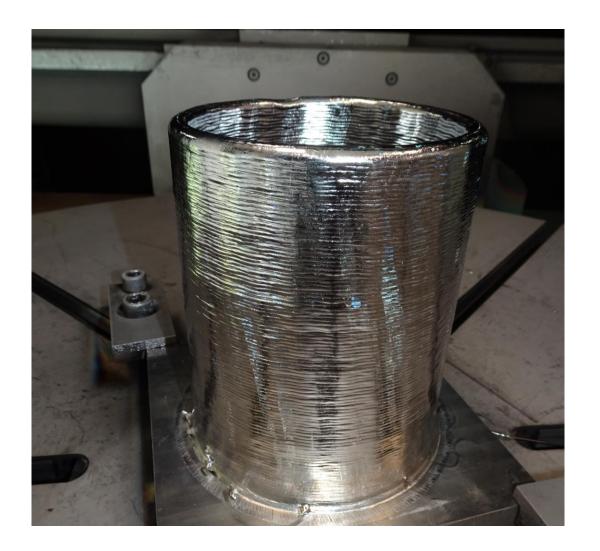


High productivity pro beam

High deposition rates achieved

- Using 1.6 mm instead of 1.2 mm almost doubles deposition rate
- Continious process (Cylinder)
- Deposition rates lower for structural components

Material	Deposition rate [kg/h] max	Volume deposition rate max [cm ³ /h]	
Copper	13.0	1448	
Inconel 718	11.9		
Ti64	6.4		



Flip frame to reduce thermal distortion

Flip frame pro beam

- Flip frame to reduce thermal distortion
- Flip at high vacuum within 1 min
- 500 mm x 400 mm x 10 mm
- (RIB5 slightly too long, but new frame possible)



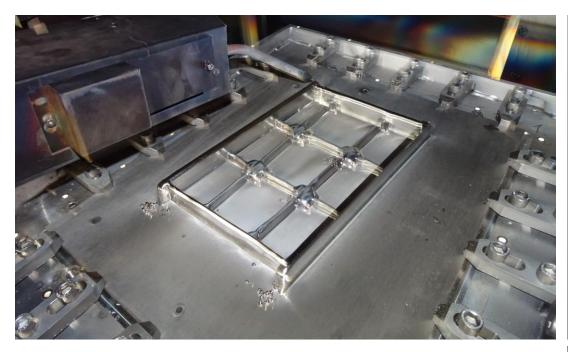




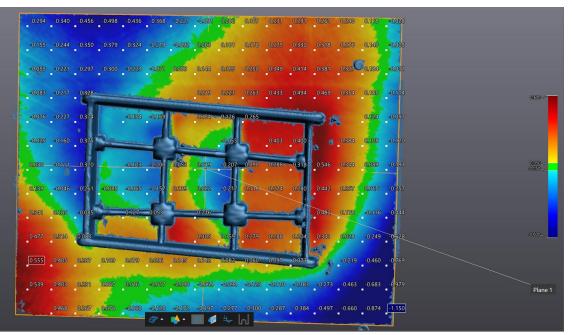


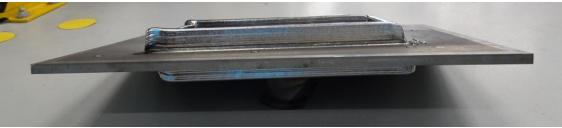


Example for result with flip frame



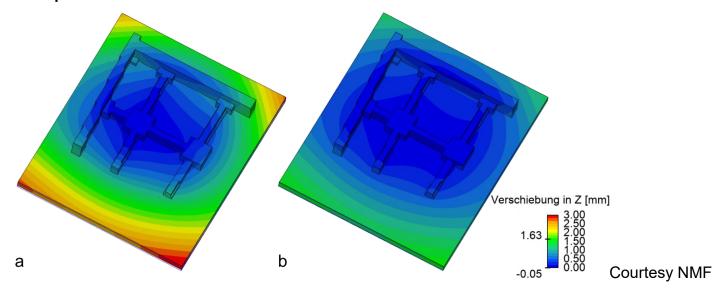
- Build time 5:22 h, 8 min each layer
- 21 layers each side, flip after each layer
- Maximum z thermal deformation <1 mm





Minimizing thermal deformation by thermal management

- Working at high vacuum, the electron beam can be used for
 - Pre-heating, in-process-heating, post-process-heating
 - Can be used for in-chamber stress relief at high vacuum (under constraint)
- Insulating or improved thermal contact of the base also affects the thermal deformation

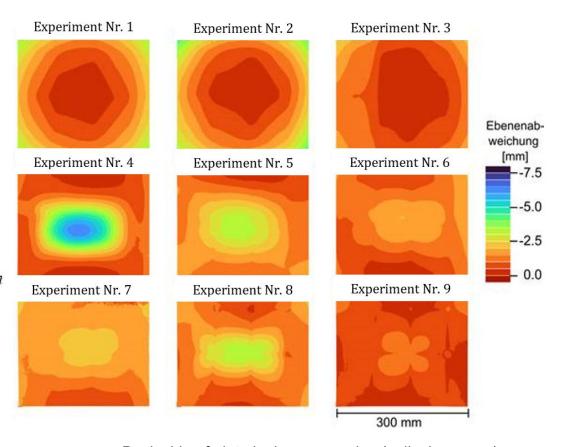


Simulation of z thermal deformation without (a) and with (b) thermal management

Minimizing thermal deformation by thermal management

- Single sided WEBAM
- 300 mm x 250 mm x 10 mm (5 mm)
- Different thermal management gives different thermal deformation
- Less than 2 mm deformation for a 5 mm plate



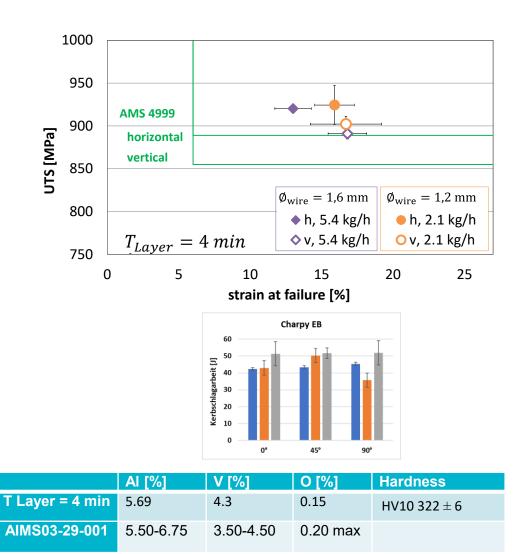


Back side of plate by laser scanning (z displacement)

Material properties and microstructure

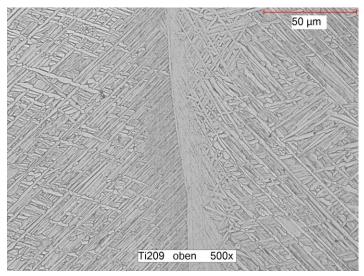
Material properties Ti6AI4V

- Material properties depend strongly on process parameters, but parameters available to suffice requirements of AMS4999
- Example: waiting time T_{layer} = 4 min (not heat treated)
 - UTS and elongation within AMS4999
 - Chemical composition within AMS4999
- No surface contamination and oxygen rich layer (α-casing) due to manufacturing at high vacuum



Microstructure Ti6AI4V pro beam

- Microstructure depends strongly on process parameters
- Example: waiting time T_{layer} = 4 min (not heat treated)

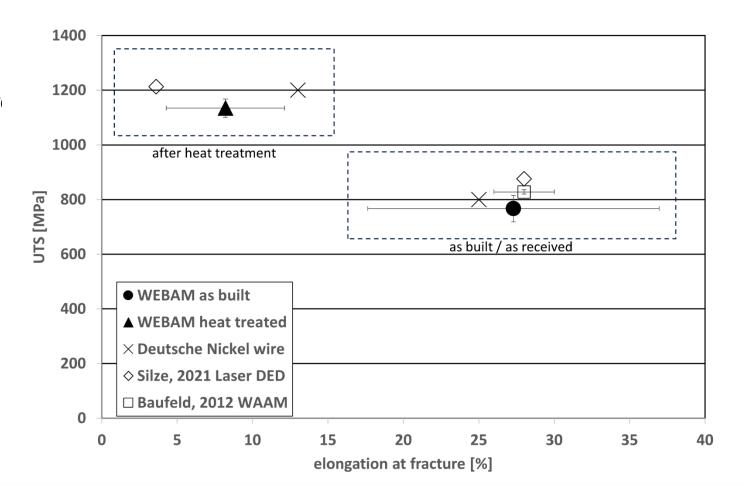






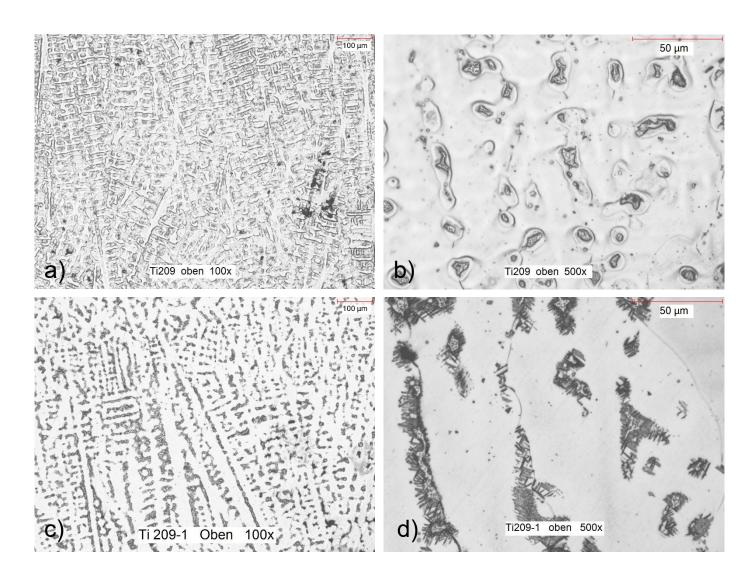
- Properties comparable to literature values
- Heat treatment increases strength and decreases elongation at fracture





Mikrostruktur IN718

 Microstructure near the top of the cylinder in the as-built (a, b) and the heat treated state (c, d) at low (a, c) and high magnification (b, d)



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